AC6329F Datasheet

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Version: V1.1

Date: 2022.07.19

AC6329F Features

High performance 32-bit RISC CPU

- RISC 32-bit CPU
- DC-96MHz operation
- 73KB data RAM
- 8KB I-cache 2way
- 1KB Rocache 1way
- 64 Vectored interrupts
- 8 Levels interrupt priority

Flexible I/O

- 11 GPIO pins
- All GPIO pins can be programmable as input or output individually
- All GPIO pins are internal pull-up/pull-down selectable individually
- CMOS/TTL level schmitt triggered input
- External wake up/interrupt on all GPIOs

Peripheral Feature

- One Full Speed USB OTG controller
- Four Multi-function 32-bit timers, support capture and PWM mode
- Three full-duplex advanced UART(DMA)
- Three SPI interface supports host and device mode (DMA)
- One IIC interface supports host and device mode
- RTC, with alarm clock and time base to wake up the chip
- 16-bit PWM generator for motor driving
- Three IQ Encoder
- 7 channels 10-bit ADC

- 1 channel 8 levels Low Power Detector
- Embedded PMU support low power mode
- 2 Crystal Oscillator
- Watchdog
- Power-on reset

Bluetooth Feature

- CMOS single-chip fully-integrated radio and baseband
- Compliant with Bluetooth
- V5.3+BR+EDR+BLE specification
- Bluetooth Piconet and Scatternet support
- Meet class2 and class3 transmitting power requirement
- Support GFSK and π/4 DQPSK all packet types
- Provides +8dbm transmitting power
- Receiver with -92dBm sensitivity
- Support

 a2dp\avctp\avdtp\avrcp\hfp\spp\smp\att\gap\
 gatt\rfcomm\sdp\l2cap profile

Power Supply

VDDIO is 1.8V to 3.4V

Packages

SOP16

Temperature

- Operating temperature: -40°C to +85°C
- Storage temperature: -65°C to +150°C

1. Block Diagram

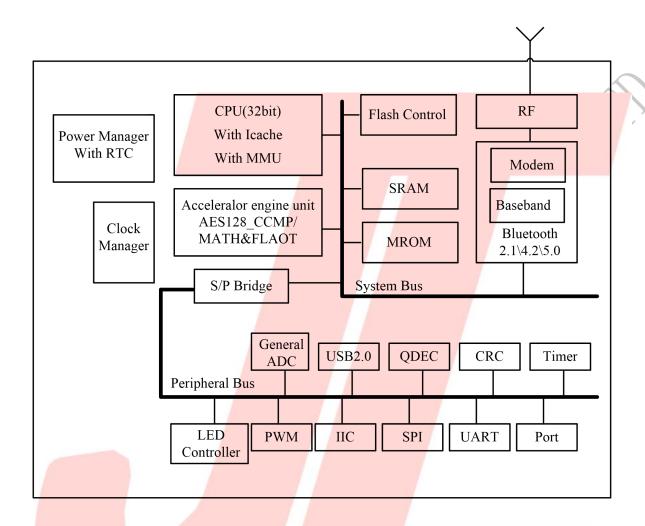


Figure 1-1 AC6329F_SOP16 Block Diagram

2. Pin Definition

2.1 Pin Assignment

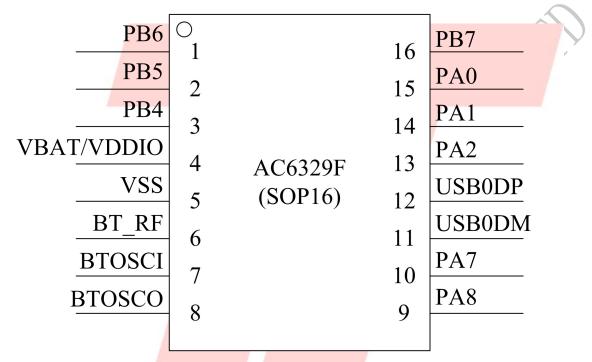


Figure 2-1 AC6329F SOP16 Package Diagram

2.2 Pin Description

Table 2-1 AC6329F_SOP16 Pin Description

PIN NO.	Name	I/O Type	Function	Other Function
1	PB6	I/O	GPIO	SPI2_CLKA: SPI2 Clock(A); ADC12: ADC Channel 12; UART2_TXC: Uart2 Data Out(C); TMR3CK;
2	PB5	I/O	GPIO (High Voltage)	SPI2_DIA: SPI2 Data In(A); UART1_RXA: Uart1 Data In(A); PWMCH3L;
3	PB4	I/O	GPIO	TMR2: Timer2 Clock In; Q-decoder2_0; SPI1_DIB: SPI1 Data In(B); ADC9: ADC Channel 9; UAR1_TXA: Uart1 Data Out(A); PWMCH3H;
	VBAT	P	LDO Power	-
4	VDDIO	P	IO Power 3.3V	
5	VSS	P	GND	
6	BT_RF	-/	RF Antenna	-
7	BTOSCI	I	BTOSCI	-
8	BTOSCO	О	BTOSCO	-
9	PA8	I/O	GPIO	TMR3: Timer3 Clock In; SPI1_DOA: SPI1 Data Out(A); IIC_SDA_C: IIC SDA(C); ADC4: ADC Channel 4; UART1_RXC: Uart1 Data In(C); PWMCH1L;
10	PA7	I/O	GPIO	TMR1: Timer1 Clock In; SPI1_CLKA: SPI1 Clock(A); IIC_SCL_C: IIC SCL(C); ADC3: ADC Channel 3; UART1_TXC: Uart1 Data Out(C); PWMCH1H;

				SPI2_DOB: SPI2 Data Out(B);
11	11 USB0DM	I/O	GPIO	IIC_SDA_A: IIC SDA(A);
11	OBBODIN	1/0	(pull down)	ADC11: ADC Channel 11;
				UART1_RXD: Uart1 Data In(D);
				SPI2_CLKB: SPI2 Clock(B);
10	HGDADD	1/0	GPIO	IIC_SCL_A: IIC SCL(A);
12	USB0DP	I/O	(pull down)	ADC10: ADC Channel 10;
		A		UART1_TXD: Uart1 Data Out(D);
		/		CAP3: Timer3 Capture;
		/		Q-decoder0_1;
13	PA2	I/O	GPIO	UARTO RXC: Uart0 Data In(C);
				UART1_RTS;
				PWM0: Timer0 PWM Output;
				Q-decoder0 0;
14	PA1	I/O	GPIO	ADC0: ADC Channel 0;
				UART0 TXC: Uart0 Data Out(C);
				UART1 CTS;
				CLKOUT1;
			GPIO	UART2 TXB: Uart2 Data Out(B);
15	15 PA0 I/O		(High Voltage)	UART2 RXB: Uart2 Data In(B);
			(Iligii , olage)	PWMCH0H;
			CDIO	
16				SPI2_DOA: SPI2 Data Out(A);
			(High Voltage)	UART2_RXC: Uart2 Data In(C);

3. Electrical Characteristics

3.1 Absolute Maximum Ratings

Table 3-1

Symbol	Parameter	Min	Max	Unit
Topt	Operating temperature	-40	+85	°C
Tstg	Storage temperature	-65	+150	°C
VDDIO	3.3V IO Input Voltage	-0.3	3.6	V

Note: The chip can be damaged by any stress in excess of the absolute maximum ratings listed below

3.2 Recommended Operating Conditions

Table 3-2

Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
VDDIO	Voltage input	1.8	3.0	3.4	V	
IL3.3	Loading current	/_	- 1	60	mA	

3.3 IO Input/Output Electrical Logical Characteristics

Table 3-4

IO input ch	aracteristics					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
$V_{\rm IL}$	Low-Level Input Voltage	-0.3	1	0.3* VDDIO	V	VDDIO = 3.3V
V_{IH}	High-Level Input Voltage	0.7* VDDIO	-	VDDIO+0.3	V	VDDIO = 3.3V
IO output o	haracteristics	A				
V_{OL}	Low-Level Output Voltage	_	_	0.33	V	VDDIO = 3.3V
V _{OH}	High-Level Output Voltage	2.7	_	-	V	VDDIO = 3.3V

3.4 Internal Resistor Characteristics

Table 3-5

Port	Drive Strength	Internal Pull-Up Resistor	Internal Pull-Down Resistor	Comment
PA1-PA8, PB4,PB6,	drive_select[11] 24mA drive_select[10] 24mA (with 120ohm res) drive_select[01] 8mA drive_select[00] 8mA (with 120ohm res)	10K	10K	USB0DM&USB0DP default pull down Internal pull-up/pull-down
PA0,PB5, PB7	8mA	10K	10K	resistance accuracy ±20% 5.PA0,PB5,PB7 can pull-up
USB0DP USB1DP	4mA	1.5K	15K	resistance to 5V
USB0DM USB1DM	4mA	180K	15K	

3.5 BT Characteristics

3.5.1 Transmitter

Basic Data Rate

Table 3-5

	Parameter		Min	Тур	Max	Unit	Test Conditions
RF Transmit Power			4	6	dBm		
	RF Power Contro	ol Range		20		dB	25°C,
	20dB Bandwidth			950	The state of the s	KHz	Power Supply
		+2MHz	1	-40		dBm	A
	Adjacent Channel	-2MHz	-	-38		dBm	VDDIO=3.3V
	Transmit Power	+3MHz		-44		dBm	2441MHz
		-3MHz		-35		dBm	

Enhanced Data Rate

Table 3-6

Paramete	Min	Тур	Max	Unit	Test Conditions	
Relative Power			-1		dB	
π/4 DQPSK	DEVM RMS		7		%	25°C,
π/4 DQPSK	DEVM 99%		12		%	Power Supply
Modulation Accuracy	DEVM Peak		17		%	VDDIO=3.3V
Adjacent Channel	+2MHz		-40		dBm	2441MHz
Transmit Power	-2MHz		-38		dBm	

+3MHz	-44	dBm
-3MHz	-35	dBm

3.5.2 Receiver

Basic Data Rate

Table 3-7

Paramete	Min	Тур	Max	Unit	Test Conditions	
Sensitivit	Sensitivity				dBm	
Co-channel Interferer	nce Rejection		-9		dB	
	+1MHz		+5		dB	25°C,
	-1MHz		+2		dB	Power Supply
Adjacent Channel	+2MHz	7	+37	77	dB	VDDIO=3.3V
Interference Rejection	-2MHz		+36		dB	2441MHz
	+3MHz		+40		dB	
	-3MHz		+35		dB	

Enhanced Data Rate

Table 3-8

Еппанска Васа Пасс		DIC C				
Paramete	Min	Тур	Max	Unit	Test Conditions	
Sensitivit		-92		dBm		
Co-channel Interferer	nce Rejection		-9		dB	
	+1MHz		+5		dB	25°C,
	-1MHz	п	+2		dB	Power Supply
Adjacent Channel	+2MHz	7	+37	No.	dB	VDDIO=3.3V
Interference Rejection	-2MHz		+36		dB	2441MHz
	+3MHz		+40		dB	
	-3MHz	7/	+35		dB	

4. Package Information

4.1 SOP16

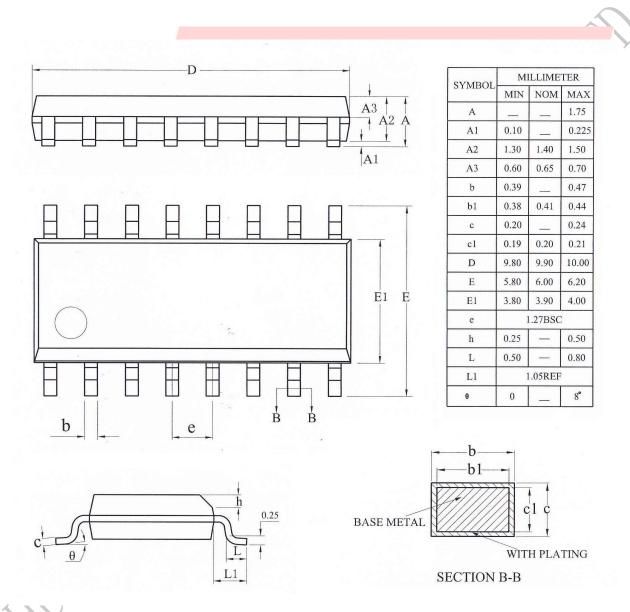


Figure 4-1 AC6329F_SOP16 Package

5. Package Type Specification



- ①Represents different packages
- ②Represents different memory sizes
 - 2: 2Mbit Flash
 - 4: 4Mbit Flash

6. Revision History

Date	Revision	Description
2021.03.05	V1.0	Initial Release
2022.07.19	V1.1	Update Bluetooth Feature